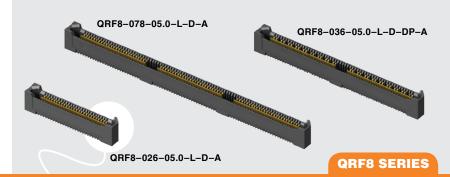




(0.80 mm) .0315"



# M BODY GROUND PLANE SOCKET

# **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?QRF8

Insulator Material: Black LCF

Contact Material:

BeCu

Ground Plane Material:

Phosphor Bronze

Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Current Rating:
Contact:

2.2 A per pin

(1 pin powered per row) Ground Plane:

8.5 A per ground plane

(1 ground plane powered)
Operating Temp Range:

-55 °C to +125 °C Voltage Rating:

RoHS Compliant:

Yes

### **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (018-026) (0.15 mm) .006" max (036-078)

#### **RECOGNITIONS**

For complete scope of recognitions see www.samtec.com/quality



## **PROTOCOLS**

• 100 GbE

#### **ALSO AVAILABLE** (MOQ Required)

· Other platings Contact Samtec.

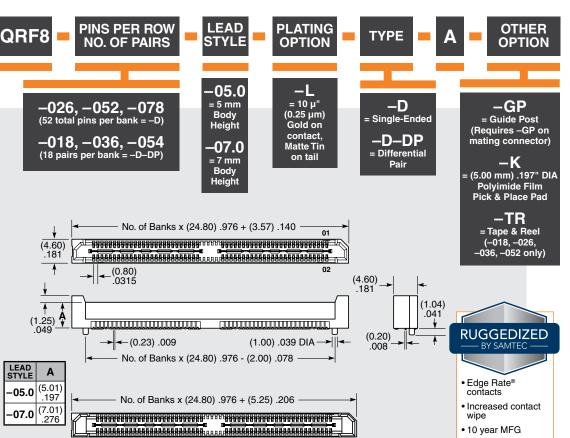
MATED HEIGHT*			
QRF8 LEAD STYLE	QRM8 LEAD STYLE		
	-02.0	-05.0	-07.0
-05.0	(7.00) .276	(10.00) .394	(12.00) .472
-07.0	(9.00) .354	(12.00) .472	(14.00) .551

Processing conditions will affect mated height. See SO Series for board space tolerances.

Note: Patented

Note: Some lengths, styles and options are non-standard, non-returnable.





Guide post option

-GP OPTION